

3A, 400V - 1000V Glass Passivated Bridge Rectifier

FEATURES

- Glass passivated junction
- Ideal for automated placement
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- UL Recognized File # E-326854
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- TV
- Monitor

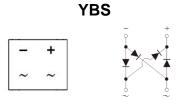
MECHANICAL DATA

- Case: YBS
- Molding compound meets UL 94V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 0.22g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _{F(AV)}	3	А	
V _{RRM}	400 - 1000	V	
I _{FSM}	110	А	
T _{J MAX}	150	°C	
Package	YBS		
Configuration	Quad		







ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)							
PARAMETER	SY	MBOL	YBS 3004G	YBS 3005G	YBS 3006G	YBS 3007G	UNIT
Marking code on the device			YBS 3004G	YBS 3005G	YBS 3006G	YBS 3007G	
Repetitive peak reverse voltage	V	, RRM	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}		280	420	560	700	V
Forward current		F(AV)		;	3		Α
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	25°C 125°C			10 8		Α
Surge peak forward current, 1 ms single half sine-wave superimposed on rated load	I _{FSM}	25°C 125°C			20 75		A
I ² t value (of a surge on-state current) ⁽¹⁾		l ² t		5	0		A ² s
Junction temperature		TJ		-55 to	+150		°C
Storage temperature	Т	STG		-55 to	+150		°C

Note:

1. Pulse test with PW=8.3 ms single half sine-wave



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance	R _{eJL}	22	°C/W
Junction-to-ambient thermal resistance	R _{eja}	61	°C/W
Junction-to-case thermal resistance	R _{eJC}	9	°C/W

Thermal Performance Note: Units mounted on recommended PCB (16mm x 16mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
	$I_F = 1.5A, T_J = 25^{\circ}C$	- V _F	0.89	1.02	V
Forward voltage per diode ⁽¹⁾	$I_F = 3.0A, T_J = 25^{\circ}C$		0.93	1.10	V
	$I_F = 1.5A, T_J = 125^{\circ}C$		0.76	0.90	V
	$I_F = 3.0A, T_J = 125^{\circ}C$		0.82	1.00	V
	$T_J = 25^{\circ}C$		-	5	μA
Reverse current @ rated V_R per diode ⁽²⁾	T _J = 125°C	I _R	-	100	μA
Junction capacitance	1 MHz, V _R =4.0V	CJ	33	-	pF

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING	INFORMATION
ONDENING	

PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
YBS30xxG (Note 1, 2)	RA	G	YBS	3,000 / 13" Plastic reel

Notes:

- 1. "xx" defines voltage from 400V (YBS3004G) to 1000V (YBS3007G)
- 2. Whole series with green compound (halogen-free)

EXAMPLE				
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
YBS3007G RAG	YBS3007G	RA	G	Green compound



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig1. Forward Current Derating Curve

Fig2. Typical Junction Capacitance

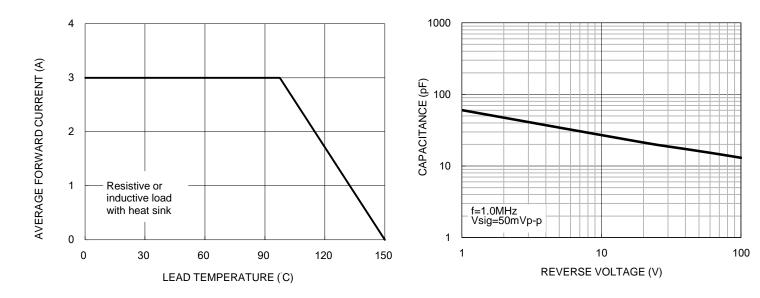
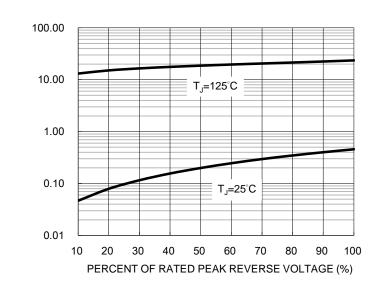
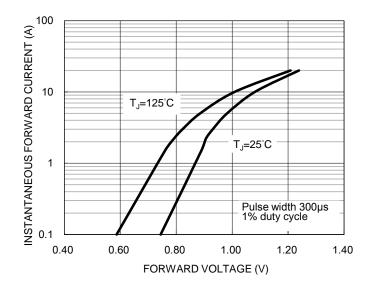


Fig3. Typical Reverse Characteristics

Fig4. Typical Forward Characteristics



INSTANTANEOUS REVERSE CURRENT (µA)

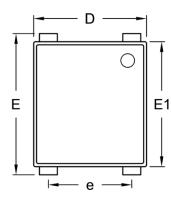


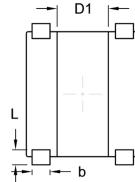


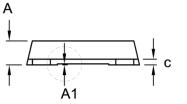
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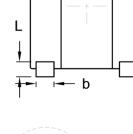
PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

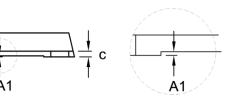
YBS





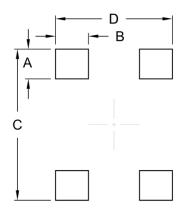






DIM.	Unit (mm)		Unit	(inch)
	Min.	Max.	Min.	Max.
A	1.30	1.50	0.051	0.059
A1	0.04	0.08	0.002	0.003
b	0.95	1.15	0.037	0.045
с	0.27	0.40	0.011	0.016
D	6.50	6.70	0.256	0.264
D1	2.90	3.10	0.114	0.122
E	7.90	8.60	0.311	0.339
E1	7.20	7.40	0.283	0.291
е	5.00	5.20	0.197	0.205
L	0.70	1.05	0.028	0.041

SUGGESTED PAD LAYOUT



MADKING	DIAGDAM



Symbol	Unit (mm)	Unit (inch)
A	1.80	0.070
В	2.00	0.078
С	9.15	0.360
D	7.10	0.279

P/N	= Marking Code
YW	= Date Code
F	= Factory Code



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